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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

BIPOLAR ANALOG INTEGRATED CIRCUIT

μ**PC358**

LOW POWER DUAL OPERATIONAL AMPLIFIERS

DESCRIPTION

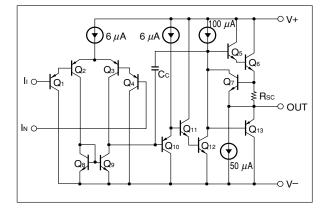
The μ PC358 is a dual operational amplifier which is designed to operate from a single power supply over a wide range of voltages. Operation from split power supplies is also possible and the power supply current drain is very low. Further advantage, the input common-mode voltage range includes ground in the linear mode.

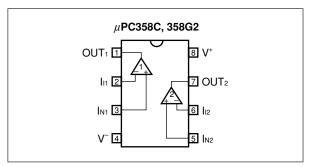
FEATURES

- Internally frequency compensation
- Wide output voltage swing V⁻ to V⁺ -1.5 V
- Common mode input voltage range includes V⁻
- Wide supply voltage range
 - 3 V to 30 V (Single)
 - ± 1.5 V to ± 15 V (Split)
- Output short circuit protection

<R> PIN CONFIGURATION (Marking Side)

EQUIVALENT CIRCUIT (1/2 Circuit)





<R> ORDERING INFORMATION

Part Number	Package
μPC358C	8-pin plastic DIP (7.62 mm (300))
μPC358G2	8-pin plastic SOP (5.72 mm (225))
μPC358G2(5)	8-pin plastic SOP (5.72 mm (225))

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ABSOLUTE MAXIMUM RATINGS (T_A = 25 $^{\circ}$ C)

	Parameter		Symbol	Ratings	Unit	
	Voltage between V ⁺ and V ⁻ Note 1		$V^+ - V^-$	-0.3 to +32	V	
	Differential Input Voltage		Vid	±32	V	
	Input Voltage Note 2		Note 2	Vi	V0.3 to V-+32	V
	Output Voltage Note		Note 3	Vo	V ⁻ -0.3 to V ⁺ +0.3	V
<r></r>	Power Dissipation	C Package	Note 4	Ρτ	350	mW
		G2 Package	Note 5		440	mW
	Output Short Circuit D	uration	Note 6		Indefinite	S
	Operating Ambient Temperature		TA	-20 to +80	°C	
	Storage Temperature		Tstg	-55 to +125	°C	

Notes 1. Reverse connection of supply voltage can cause destruction.

- 2. The input voltage should be allowed to input without damage or destruction independent of the magnitude of V⁺. Either input signal should not be allowed to go negative by more than 0.3 V. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.
- 3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.
- 4. Thermal derating factor is -5.0 mW/°C when operating ambient temperature is higher than 55 °C.
- 5. Thermal derating factor is -4.4 mW/°C when operating ambient temperature is higher than 25 °C.
- 6. Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4 and Note 5.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage (Split)	V±	±1.5		±15	V
Supply Voltage (V ⁻ = GND)	V+	+3		+30	V

μ**PC358C**, μ**PC358G2**

ELECTRICAL CHARACTERISTICS (T_A = 25 °C, V⁺ = +5 V, V⁻ = GND)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	Vio	Rs = 0 Ω		±2	±7	mV
Input Offset Current	lio			±5	±50	nA
Input Bias Current Note 7	Ів			45	250	nA
Large Signal Voltage Gain	Av	$R_L \ge 2 \ k\Omega$	25	100		V/mA
Supply Current Note 8	lcc	$R_L = \infty$, $I_O = 0$ A		0.7	1.2	mA
Common Mode Rejection Ratio	CMR		65	70		dB
Supply Voltage Rejection Ratio	SVR		65	100		dB
Output Voltage Swing	Vo	$R_L = 2 k\Omega$ (Connect to GND)	0		V ⁺ -1.5	V
Common Mode Input Voltage Range	Vicм		0		V ⁺ -1.5	V
Output Current (SOURCE)	lo source	$V_{IN}^{+} = +1 V, V_{IN}^{-} = 0 V$	20	40		mA
Output Current (SINK)	lo sink	$V_{IN}^{-} = +1 V, V_{IN}^{+} = 0 V$	10	20		mA
		$V_{IN}^{-} = +1 V, V_{IN}^{+} = 0 V,$ Vo = 200 mV	12	50		μΑ
Channel Separation		f = 1 kHz to 20 kHz		120		dB

Notes 7. Input bias currents flow out from IC. Because each currents are base current of PNP-transistor on input stage.

8. This current flows irrespective of the existence of use.

μ PC358G2(5) ELECTRICAL CHARACTERISTICS (T_A = 25 °C, V⁺ = +5 V, V⁻ = GND)

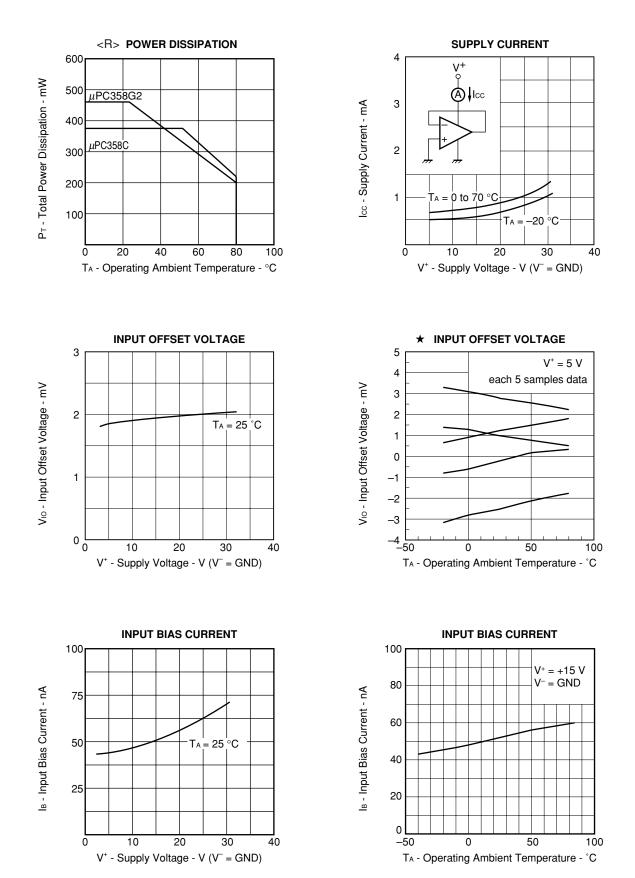
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	Vio	Rs = 0 Ω		±2	±3	mV
Input Offset Current	lio			±5	±50	nA
Input Bias Current Note	7 Ів			45	60	nA
Large Signal Voltage Gain	Av	$R_L \ge 2 \ k\Omega$	50	100		V/mA
Supply Current Note	8 Icc	$R_L = \infty$, Io = 0 A		0.7	0.9	mA
Common Mode Rejection Ratio	CMR		65	70		dB
Supply Voltage Rejection Ratio	SVR		65	100		dB
Output Voltage Swing	Vo	$R_L = 2 k\Omega$ (Connect to GND)	0		V ⁺ -1.5	V
Common Mode Input Voltage Rang	је V ісм		0		V ⁺ -1.4	V
Output Current (SOURCE)	lo source	$V_{IN}^{+} = +1 V, V_{IN}^{-} = 0 V$	30	40		mA
Output Current (SINK)	Іо ѕілк	$V_{IN}^{-} = +1 V, V_{IN}^{+} = 0 V$	15	20		mA
		$V_{IN}^{-} = +1 V, V_{IN}^{+} = 0 V,$ Vo = 200 mV	30	50		μA
Channel Separation		f = 1 kHz to 20 kHz		120		dB

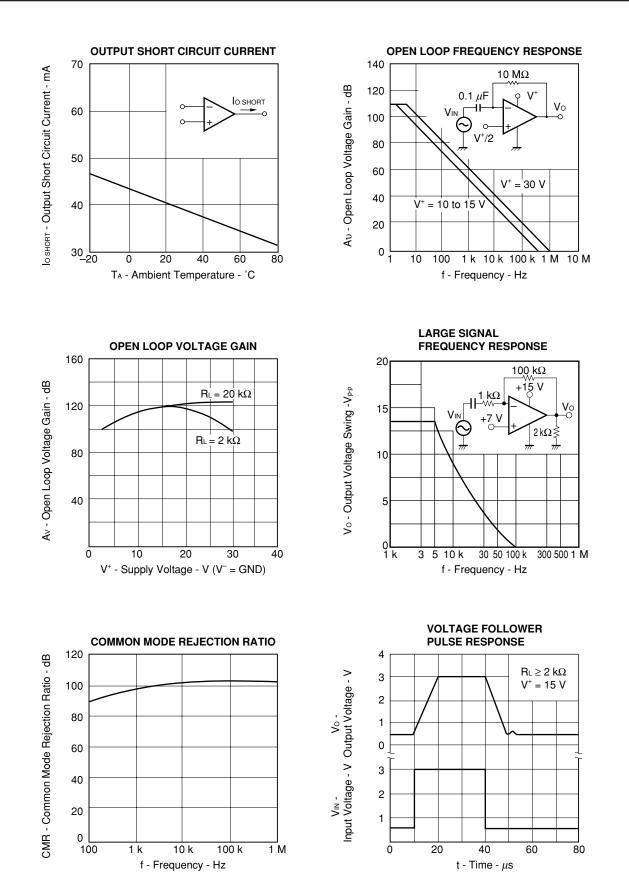
Notes 7. Input bias currents flow out from IC. Because each currents are base current of PNP-transistor on input stage.

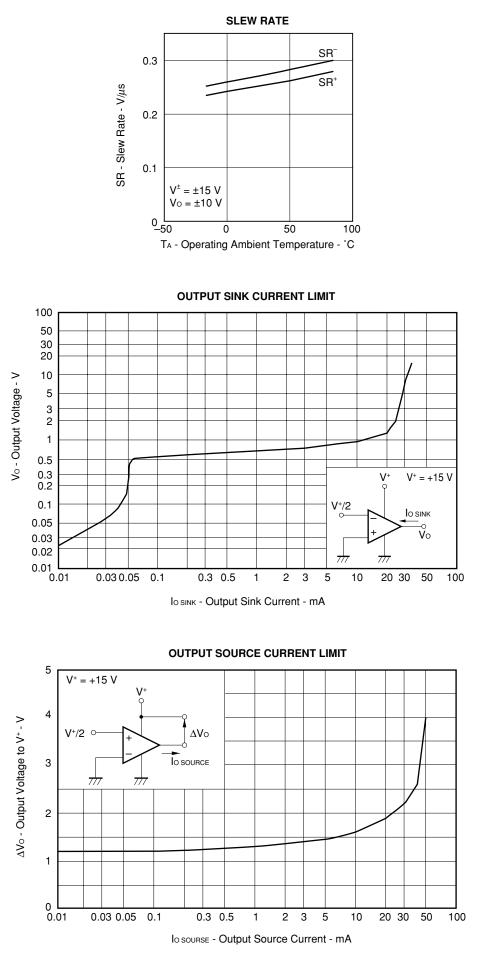
8. This current flows irrespective of the existence of use.

TYPICAL PERFORMANCE CHARACTERISTICS (TA = 25 °C, TYP.)

NEC

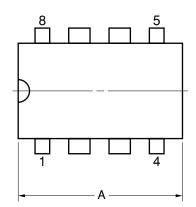


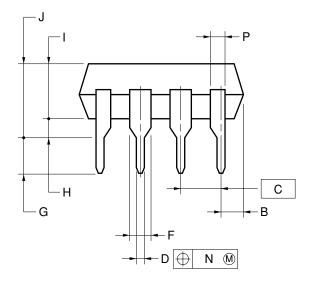


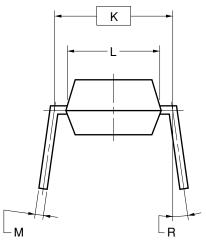


<R> PACKAGE DRAWINGS

8-PIN PLASTIC DIP (7.62mm(300))





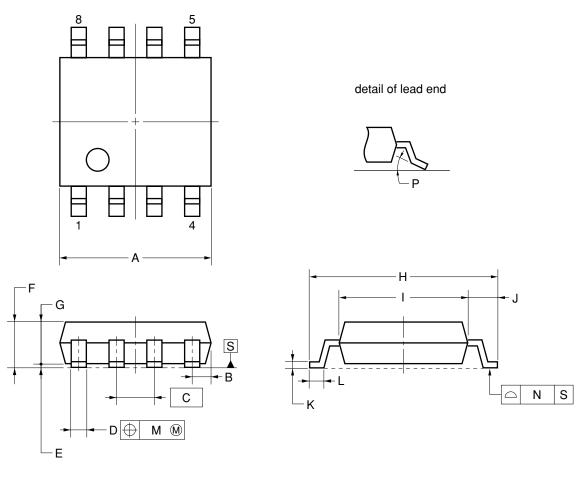


NOTES

- 1. Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.
- 2. Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS
А	10.16 MAX.
В	1.27 MAX.
С	2.54 (T.P.)
D	0.50±0.10
F	1.4 MIN.
G	3.2±0.3
Н	0.51 MIN.
<u> </u>	4.31 MAX.
J	5.08 MAX.
K	7.62 (T.P.)
L	6.4
М	$0.25^{+0.10}_{-0.05}$
N	0.25
Р	0.9 MIN.
R	0~15°
l	P8C-100-300B,C-2

8-PIN PLASTIC SOP (5.72 mm (225))



NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
А	$5.2 \begin{array}{c} +0.17 \\ -0.20 \end{array}$
В	0.78 MAX.
С	1.27 (T.P.)
D	$0.42\substack{+0.08\\-0.07}$
E	0.1±0.1
F	1.59±0.21
G	1.49
Н	6.5±0.3
I	4.4±0.15
J	1.1±0.2
к	$0.17\substack{+0.08\\-0.07}$
L	0.6±0.2
М	0.12
N	0.10
Р	3° ^{+7°} -3°
	S8GM-50-225B-6

<R> RECOMMENDED SOLDERING CONDITIONS

The μ PC358 should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Type of Surface Mount Device

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 235 °C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210 °C or higher), Maximum number of reflow processes: 3 time.	IR35-00-3
Vapor phase soldering	Peak temperature: 215 °C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200 °C or higher), Maximum number of reflow processes: 3 time.	VP15-00-3
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120 °C or below (Package surface temperature).	WS60-00-1
Partial heating method	Pin temperature: 350 °C or below, Heat time: 3 seconds or less (Per each side of the device).	P350

µPC358G2: 8-pin plastic SOP (5.72 mm (225))

Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

Types of Through-hole Device

μPC358C: 8-pin plastic DIP (7.62 mm (300))

Process	Conditions	
Wave soldering (only to leads)	Solder temperature: 260 °C or below, Flow time: 10 seconds or less.	
Partial heating method	Pin temperature: 300 °C or below, Heat time: 3 seconds or less (per each lead).	

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

REFERENCE DOCUMENTS

QUALITY GRADES ON NEC SEMICONDUCTOR DEVICES SEMICONDUCTOR DEVICE MOUNT MANUAL NEC SEMICONDUCTOR DEVICE RELIABILITY/ QUALITY CONTROL SYSTEM - STANDARD LINEAR IC C11531E http://www.necel.com/pkg/en/mount/index.html IEI-1212

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